

## Sn100e No Clean Solder Wire 49500 Technical Data Sheet

ISO 9001:2008 Registered Quality System. Burlington, Ontario, CANADA SAI Global File: 004008

49500

#### **Description**

The 49500 Sn100e No Clean Solder Wire is an electronic grade solder wire. It uses a high-purity, eutectic tin/copper/cobalt alloy, which is complemented with a no clean, synthetically refined, splatter-proof, resin flux core. The 49500 solder meets J-STD-004B, ASTM B 32, and exceeds J-STD-006C specifications.

This solder is a great lead-free alternative to leaded solders. It generally provides better wetting, contact angle, flow, and visual appearance than typical Sn63/Pb37 no clean solders, while still delivering excellent performance characteristics. It offers superior solder penetration into plated through holes and surface mount interconnects. Further, it is a suitable replacement for SAC305 solder since the 49500 forms brighter, shinier, and less grainy joints. Furthermore, it is less expensive.

The 49500 solders achieve a consistent solder and flux percentage through a state-of-the-art, extrusion, wire-drawing machine. This machine continually monitors the wire to prevent voids and ensure consistency, providing a top-grade solder wire.

#### **Benefits & Features**

- **Eutectic alloy** (liquidus = solidus temperature)
- Alloy exceeds J-STD-006C and meets ASTM B 32 purity requirements
- Flux meets J-STD-004B
- Spreads like rosin activated flux
- Virtually non-splattering
- Non-corrosive
- Non-conductive residue
- Halide free

## Wire Size Availability

Cat No.	Std. Wire Gauge	Diameter		Packaging	Size
49500	21	0.81 mm	0.032 in	Spool	1 lb

#### **General Flux Parameters**

Properties	Value
Residue Removal Flux Percentage Flux Feature Shelf Life	Not required 3.3% Wets and spreads like a RA type flux and virtually non-splattering. 5 y

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COMPLIANCE

- ✓ Dobb Frank (DRC conflict free)
- ✓ REACH (compliant)
- √ RoHS (compliant)

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### **Flux Core Properties**

The synthetically refined resin wets and spreads like a RA flux. This no clean flux is virtually non-splattering. It gives rise to a hard, non-conductive, and non-corrosive residue.

Physical Properties	Method	Value
Flux Classification	J-STD-004B	REL0
	EN29454-1	Type 1.1.3
Flux Type		Resin
Flux Activity		Low
Halides %(wt)		<0.05%
Solid Flux Color	Visual	Lightly opaque
Softening Point of Flux Extract		24 °C [75 °F]
Acid Number (mgKOH/g sample)	IPC-TM-650 2.3.13	190-210
Copper Mirror	IPC-TM-650 2.3.32	No removal
Silver Chromate—Chlorides + Bromides	IPC-TM-650 2.3.33	Pass
Solder Spread	IPC-TM-650 2.4.46	130 mm <sup>2</sup>
Flux Residue Dryness	IPC-TM-650 2.4.47	Pass
Spitting of Flux-Cored Wire Solder	IPC-TM-650 2.4.48	0.30%
Corrosion Test	IPC-TM-650 2.6.15	Non-corrosive
Surface Insulation Resistance (SIR)	IPC-TM-650 2.6.3.3	$2.3 \times 10^{11} \Omega$
Bellcore (Telecordia)	Bellcore GR-78-CORE 13.1.3	$6.1 \times 10^{11} \Omega$
Electromigration	Bellcore GR-78-CORE 13.1.4	Pass
Post Reflow Residue	TGA Analysis	55%
Cleaning Requirements	_	Optional

### **Sn100e Alloy Typical Literature Properties**

Physical Properties	Value a)	
Color	Silvery-white metal	
Density @26 °C [78 °F]	7.4 g/cm <sup>3</sup>	
Tensile Strength Elongation	28 N/mm <sup>2</sup> [4 100 lb/in <sup>2</sup> ] 27%	
Shear Strength	~20 N/mm <sup>2</sup> [~2 900 lb/in <sup>2</sup> ]	
Electrical Properties	Value	
Volume Resistivity	12.3 μΩ·cm	
Electrical Conductivity b)	15% IACS	

a)  $N/mm^2 = mPa$ ;  $Ib/in^2 = psi$ ;

b) International Annealed Copper Standard: 100% give  $5.8 \times 10^7$  S/m.

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Thermal Properties	Value
Melting Point, Solidus	228 °C [442 °F]
Melting Point, Liquidus	228 °C [442 °F]
Tip Temperature Upper Limit	Do not exceed 425 °C [800 °F]
Coefficient of Thermal Expansion (CTE) c)	23.5 ppm/°C
Thermal Conductivity	82 W/(m·K)
Specific Heat Capacity	294 J/(kg·K)

NOTE: This table present typical literature values for Sn99.5/Cu0.5/Co alloys.

c) CTE for pure tin; unit conversions: ppm/°C =  $\mu$ m/(m·K) = in/in/°C × 10<sup>-6</sup> = unit/unit/°C × 10<sup>-6</sup>

#### **Solder Alloy Composition**

Properties	Value	<b>Properties</b>	J-STD-006C	49500 Values
MAIN INGREDIENTS	COMPOSITION	IMPURITIES a)	REQUIREMENTS	SPECIFICATIONS
Sn	99.3 to 99.7%	Sb	≤0.20% Max	≤0.025% Max
Cu	0.49 to 0.51%	Ag	≤0.10% Max	≤0.001% Max
Co	<0.1%	Bi	≤0.10% Max	≤0.01% Max
		In	≤0.10% Max	≤0.01% Max
RoHS		Pb	≤0.10% Max	≤0.05% Max
		Au	≤0.05% Max	≤0.0002% Max
		As	≤0.03% Max	≤0.0035% Max
		Fe	≤0.02% Max	≤0.005% Max
		Ni	≤0.01% Max	≤0.006% Max
		Al	≤0.005% Max	≤0.001% Max
		Zn	≤0.003% Max	≤0.001% Max
		Cd	≤0.002% Max	≤0.001% Max

a) Exceeds the requirements of J-STD-006C and meets ASTM B 32.

#### **Storage**

Protect from direct heat or sunlight. Keep at around between 18 to 27 °C [65 to 80 °F].

### Cleaning

The flux residue does not need to be removed for typical applications. If removal is desired, a solvent system like the MG~4140 can be used. For best results, warm the cleaning solution to about 40 °C [104 °F].

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#### **Health and Safety**

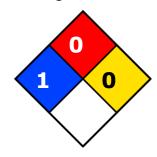
Please see the 49500 **Safety Data Sheet** (SDS) for more details on transportation, storage, handling and other security guidelines.

Health and Safety: Avoid breathing fumes. Wash hands thoroughly after use. Do not ingest.

#### **HMIS® RATING**

HEALTH:	*	1
FLAMMABILITY:		0
PHYSICAL HAZARD:		0
PERSONAL PROTECTION:		

**NFPA® 704 CODES** 



Approximate HMIS and NFPA Risk Ratings Legend:

0 (Low or none); 1 (Slight); 2 (Moderate); 3 (Serious); 4 (Severe)

### **Soldering Instructions**

#### To achieve best hand-soldering results

- 1. Set the tip temperature between 370-425 °C [700-800 °F].
- 2. Place the solder tip in contact with the joint connection (lead/pad surface) at an angle of around 50° to heat the parts to be soldered.
- 3. While the soldering tip is applied, touch the solder wire to the opposite side of the soldering joint, not to the soldering tip.
- 4. Immediately after the solder has flowed around the whole heated connection, remove the solder wire and remove soldering tip from connection.

TIP! Do not move the connection while the solder is cooling.

WARNING! Avoid putting too much or too little solder.

**ATTENTION!** To avoid damage, do not overheat electrical component.

#### **Packaging and Supporting Products**

Cat. No.	Form	Package	Net Weight	
49500-454G	Solid wire	Spool	454 g	1.0 lb



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### **Technical Support**

Contact us regarding any questions, improvement suggestions, or problems with this product. Application notes, instructions, and FAQs are located at <a href="https://www.mgchemicals.com">www.mgchemicals.com</a>.

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#### Warranty

M.G. Chemicals Ltd. warranties this product for 12 months from the date of purchase by the end user.

M.G. Chemicals Ltd. makes no claims as to shelf life of this product for the warranty. The liability of M.G.

Chemicals Ltd. whether based on its warranty, contracts, or otherwise shall in no case include incidental or consequential damage.

#### **Disclaimer**

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